

## **Description**

The RRR030P03TL uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

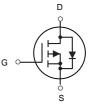


#### **General Features**

 $V_{DS} = -30V I_D = -4.2A$   $R_{DS(ON)} < 54m\Omega@V_{GS} = 10V$  $R_{DS(ON)} < 77m\Omega@V_{GS} = 4.5V$ 

## **Application**

Battery protection
Load switch
Uninterruptible power supply



P-Channel MOSFET

## **Package Marking and Ordering Information**

| Product ID  | Pack               | Brand      | Qty(PCS) |
|-------------|--------------------|------------|----------|
| RRR030P03TL | SOT-23-3L(SOT-346) | HXY MOSFET | 3000     |

# Absolute Maximum Ratings (T<sub>A</sub>=25 ℃ unless otherwise noted)

| Symbol          | Parameter  | Limit      | Unit |  |
|-----------------|--|------------|------|--|
| V <sub>DS</sub> | Drain-Source Voltage                             | -30        | V    |  |
| Vgs             | Gate-Source Voltage                              | ±12        | V    |  |
| I <sub>D</sub>  | Drain Current-Continuous                         | -4.2       | A    |  |
| Ірм             | Drain Current-Pulsed (Note 1)                    | -30        | A    |  |
| P <sub>D</sub>  | Maximum Power Dissipation                        | 1.2        | W    |  |
| Тл,Тѕтс         | Operating Junction and Storage Temperature Range | -55 To 150 | °C   |  |
| ReJA            | Thermal Resistance,Junction-to-Ambient (Note 2)  | 104        | °C/W |  |
|                 |  |            |      |  |



#### P-Channel Enhancement Mode MOSFET

| Electrical Characteristics (T <sub>A</sub> =25°Cunless otherwise noted) |
|---|
|---|

| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>            | V <sub>DS</sub> =-24V,V <sub>GS</sub> = 0V               | -    | -   | -1   | μΑ |
|------------------------------------|-----------------------------|--|------|-----|------|----|
| Gate-Body Leakage Current          | I <sub>GSS</sub>            | V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V                | -    | -   | ±100 | nA |
| On Characteristics (Note 3)        | On Characteristics (Note 3) |  |      |     |      |    |
| Gate Threshold Voltage             | V <sub>GS(th)</sub>         | V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA | -0.7 | -1  | -1.3 | V  |
|                                    |                             | V <sub>GS</sub> =-10V, I <sub>D</sub> =-4.2A             | -    | 46  | 54   | mΩ |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub>         | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A              | -    | 58  | 77   | mΩ |
|                                    |                             | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-1A              |      | 74  | 130  | mΩ |
| Forward Transconductance           | <b>g</b> FS                 | V <sub>DS</sub> =-5V,I <sub>D</sub> = -4.2A              | -    | 10  | -    | S  |
| Dynamic Characteristics (Note4)    |                             |  |      |     |      |    |
| Input Capacitance                  | C <sub>lss</sub>            | V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V,<br>F=1.0MHz   | -    | 880 | -    | PF |
| Output Capacitance                 | C <sub>oss</sub>            |  | -    | 105 | -    | PF |
| Reverse Transfer Capacitance       | C <sub>rss</sub>            |  | -    | 65  | -    | PF |
| Switching Characteristics (Note 4) |                             |  |      |     |      |    |
| Turn-on Delay Time                 | t <sub>d(on)</sub>          |  | -    | 7   | -    | nS |
| Turn-on Rise Time                  | t <sub>r</sub>              | V <sub>DD</sub> =-15V,I <sub>D</sub> =-4.2A              | -    | 3   | -    | nS |
| Turn-Off Delay Time                | $t_{d(off)}$                | $V_{GS}$ =-10 $V$ , $R_{GEN}$ =6 $\Omega$                | -    | 30  | -    | nS |
| Turn-Off Fall Time                 | t <sub>f</sub>              |  | -    | 12  | -    | nS |
| Total Gate Charge                  | Qg                          |  | -    | 8.5 | -    | nC |
| Gate-Source Charge                 | Q <sub>gs</sub>             |  | -    | 1.8 | -    | nC |
| Gate-Drain Charge                  | Q <sub>gd</sub>             |  | -    | 2.7 | -    | nC |
| Drain-Source Diode Characteristics |                             |  |      |     |      |    |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>             | V <sub>GS</sub> =0V,I <sub>S</sub> =-4.2A                | -    | -   | -1.2 | V  |
|                                    | •                           |  |      |     |      |    |

#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production



## Typical Electrical and Thermal Characteristics

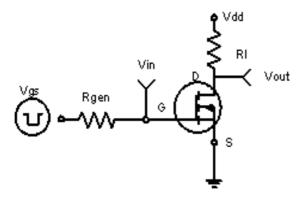
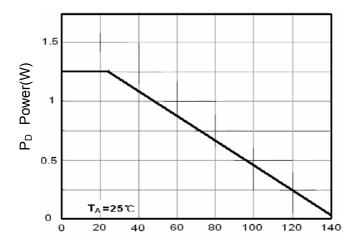
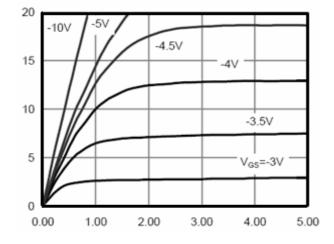


Figure 1:Switching Test Circuit



 $T_J$ -Junction Temperature ( ${}^{\circ}$ C) Figure 3 Power Dissipation



Ip- Drain Current (A)

Vds Drain-Source Voltage (V) Figure 5 Output Characteristics

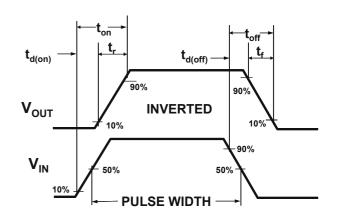


Figure 2:Switching Waveforms

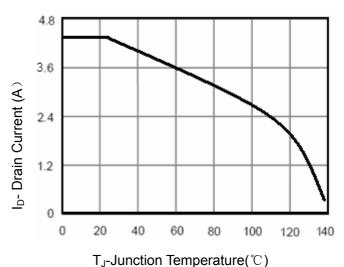


Figure 4 Drain Current

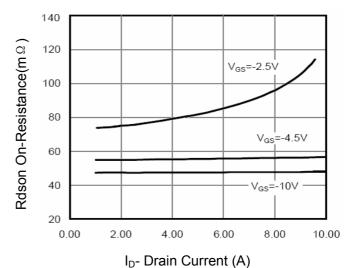
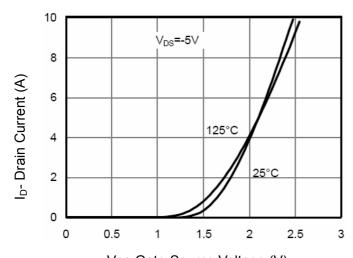
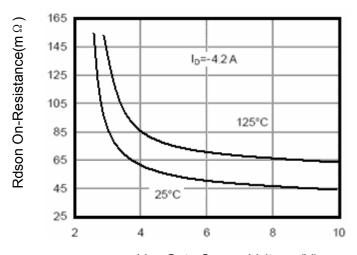


Figure 6 Drain-Source On-Resistance



Vgs Gate-Source Voltage (V) Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V) Figure 9 Rdson vs Vgs

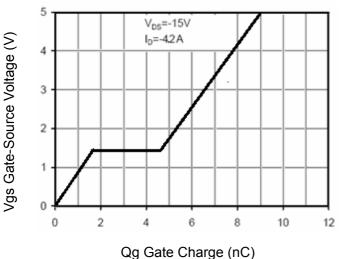


Figure 11 Gate Charge

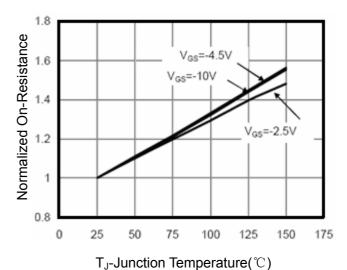
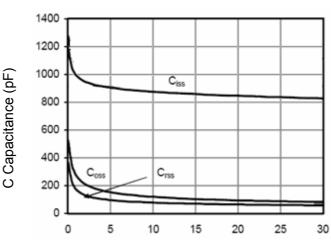
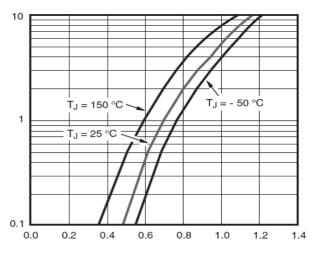


Figure 8 Drain-Source On-Resistance



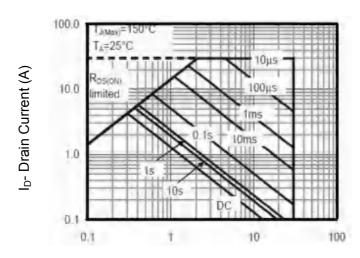
Vds Drain-Source Voltage (V) Figure 10 Capacitance vs Vds



Is- Reverse Drain Current (A)

Vsd Source-Drain Voltage (V)
Figure 12 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)
Figure 13 Safe Operation Area

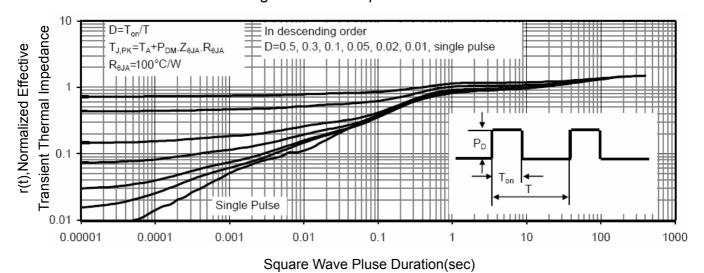
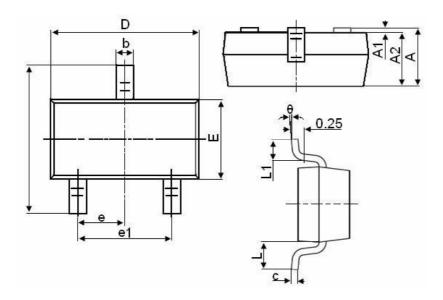


Figure 14 Normalized Maximum Transient Thermal Impedance



# SOT-23-3L(SOT-346) Package Information



| Symbol | Dimensions in Millimeters |          |  |  |
|--------|---------------------------|----------|--|--|
|        | MIN.                      | MAX.     |  |  |
| А      | 1.050                     | 1.250    |  |  |
| A1     | 0.000                     | 0.100    |  |  |
| A2     | 1.050                     | 1.150    |  |  |
| b      | 0.300                     | 0.500    |  |  |
| С      | 0.100                     | 0.200    |  |  |
| D      | 2.800                     | 3.000    |  |  |
| E      | 1.500                     | 1.700    |  |  |
| E1     | 2.650                     | 2.950    |  |  |
| е      |                           | 0.950TYP |  |  |
| e1     | 1.800                     | 2.000    |  |  |
| L      |                           | 0.550REF |  |  |
| L1     | 0.300                     | 0.600    |  |  |
| θ      | 0°                        | 8°       |  |  |



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